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Docket No. 215207US0PCT

IN RE APPLICATION OF: Hiroshi ORIKABE, et al.

SERIAL NO: 09/926,370

FILED: December 28, 2001

FOR: THERMOSETTING RESIN COMPOSITION AND FLEXIBLE CIRCUIT OVERCOATING MATERIAL
COMPRISING THE SAME

COMMISSIONER FOR PATENTS

ALEXANDRIA, VIRGINIA 22313

SIR:

Transmitted herewith is an Amendment and Request for Reconsideration in the above-identified application.

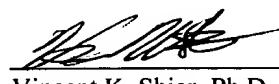
- No additional fee is required
- Small entity status of this application under 37 C.F.R. §1.9 and §1.27 is claimed.
- Additional documents filed herewith:

The Fee has been calculated as shown below:

CLAIMS	CLAIMS REMAINING		HIGHEST NUMBER PREVIOUSLY PAID	NO. EXTRA CLAIMS	RATE	CALCULATIONS
TOTAL	12	MINUS	20	0	x \$18 =	\$0.00
INDEPENDENT	3	MINUS	3	0	x \$86 =	\$0.00
		<input type="checkbox"/> MULTIPLE DEPENDENT CLAIMS			+ \$290 =	\$0.00
						TOTAL OF ABOVE CALCULATIONS
		<input type="checkbox"/> Reduction by 50% for filing by Small Entity				\$0.00
		<input type="checkbox"/> Recordation of Assignment			+ \$40 =	\$0.00
						TOTAL
						\$0.00

- A check in the amount of \$0.00 is attached.
- Credit card payment form is attached to cover the fees in the amount of \$0.00
- Please charge any additional Fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.
- If these papers are not considered timely filed by the Patent and Trademark Office, then a petition is hereby made under 37 C.F.R. §1.136, and any additional fees required under 37 C.F.R. §1.136 for any necessary extension of time may be charged to Deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.

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DOCKET NO.: 215207US0PCT



IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF

HIROSHI ORIKABE, ET AL.

: EXAMINER: KEEHAN, C. M.

SERIAL NO: 09/926,370

:

FILED: DECEMBER 28, 2001

: GROUP ART UNIT: 1712

FOR: THERMOSETTING RESIN COMPOSITION AND FLEXIBLE CIRCUIT
OVERCOATING MATERIAL COMPRISING THE SAME:

AMENDMENT AND REQUEST FOR RECONSIDERATION

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313-1450

SIR:

In response to the Office Action dated March 22, 2004, reconsideration is respectfully requested in view of the following amendments and remarks.

Amendments to the Claims begins on page 2 of this response.

Support for the Amendment begins on page 7 of this response.

Remarks begin on page 8 of this response.